ABSTRACT

A film material having a first surface S1 and a second surface S2 on the back side thereof. The film material includes one or more thermocompression bonding layers. The thermocompression bonding layer is a resin layer that is non-adhesive at 25°C, has thermocompression bondability at a temperature 10°C or more higher than the glass transition temperature of the thermocompression bonding layer, and does not melt at 250°C or lower. The outermost layers on both the first surface side and the second surface side are the thermocompression bonding layers.

Fig. 1